

Applicant : Hisashi Shimizu et al.
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119638M/HW

a seal which is disposed in a periphery of said substrate; and
a transparent substrate which is fixed to said hybrid integrated circuit substrate via
said seal to enclose the first and second electrodes and the light emitting element within a
sealed space formed between said hybrid integrated circuit substrate and said transparent
substrate, wherein the hybrid integrated circuit substrate is made of glass.--